

Technical Data Sheet

0805 Package Chip LED (0.8mm Height)

17-215/G6C-FN2P2B/3T

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version



- The 17-215 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

D. AM.	Chip	F. W. I.C.L.	Resin Color	
Part No.	Material	Emitted Color		
17-215/G6C-FN2P2B/3T	AlGaInP	Brilliant Yellow Green	Water Clear	

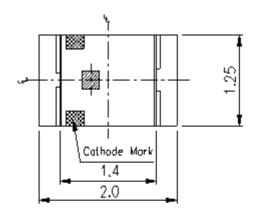


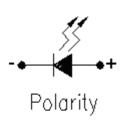
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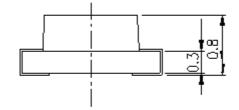
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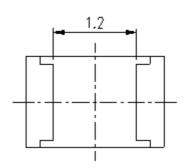
Package Outline Dimensions

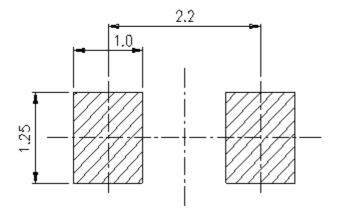






For reflow soldering (propose)





Note: The tolerances unless mentioned are ± 0.1 mm, Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Symbol Rating	
Reverse Voltage	V_R	5	V
Forward Current	I_{F}	25	mA
Peak Forward Current (Duty 1/10 @1KHz)	$ m I_{FP}$	60	mA
Power Dissipation	P_d	60	mW
Electrostatic Discharge(HBM)	ESD	2000	V
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{stg}	-40 ~ +90	$^{\circ}\!\mathbb{C}$
Soldering Temperature	$T_{ m sol}$	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

		` `				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_{\rm v}$	36.0		72.0	mcd	
Viewing Angle	$2 heta_{ ext{1/2}}$		130		deg	
Peak Wavelength	λp		575		nm	
Dominant Wavelength	λd	570.0		574.5 nm	$I_F = 20 \text{mA}$	
Spectrum Radiation Bandwidth	Δλ		20		nm	
Forward Voltage	V_{F}	1.75		2.35	V	
Reverse Current	I_R			10	μΑ	V _R =5V

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

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Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
N2	36.0	45.0		
P1	45.0	57.0	mcd	$I_F = 20 \text{mA}$
P2	57.0	72.0		

Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
F	CC2	570.0	571.5	$ m _{nm}$ $ m I_{F}$ =20n	
	CC3	571.5	573.0		$I_F = 20 \text{mA}$
	CC4	573.0	574.5		

Bin Range Of Luminous Voltage

Group	Bin	Min	Max	Unit	Condition
	0	1.75	1.95		
В	1	1.95	2.15	V	$I_F = 20 \text{mA}$
	2	2.15	2.35		

- 1. Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

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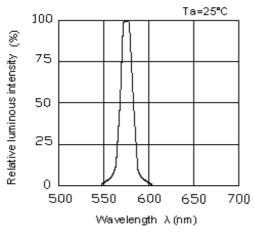
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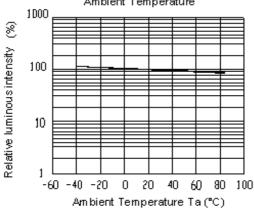
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Typical Electro-Optical Characteristics

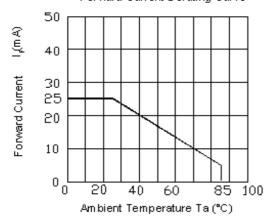




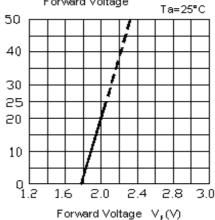
Luminous Intensity vs. Ambient Temperature



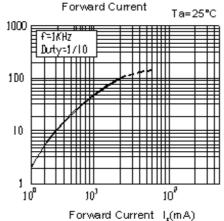
Forward Current Derating Curve



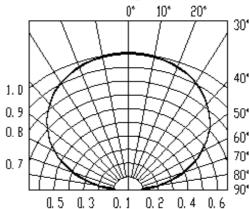
Forward Current vs. Forward Voltage



Lum in ous Intensity vs



Radiation Diagram Ta=25°C





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Label explanation

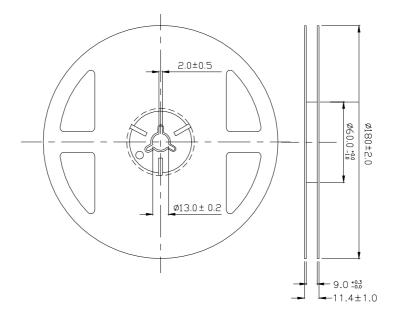
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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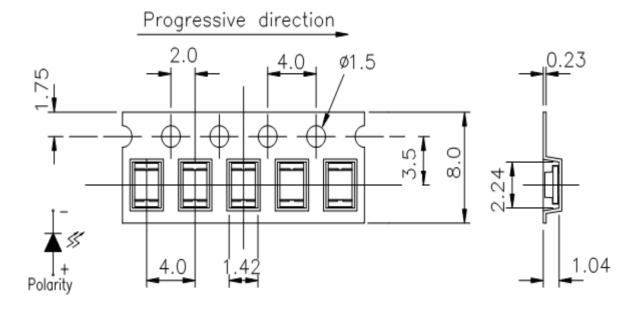
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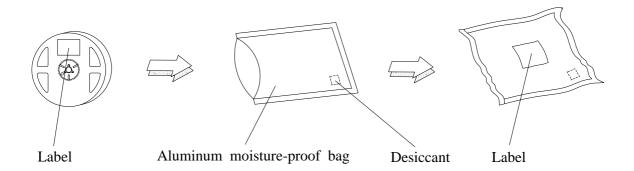
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Carrier Tape Dimensions: Loaded quantity 3000PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition Test Hours/Cycle		Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min		0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85% RH	1000 Hrs.	22 PCS.	0/1



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Precautions For Use

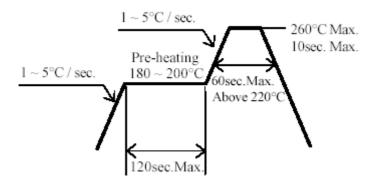
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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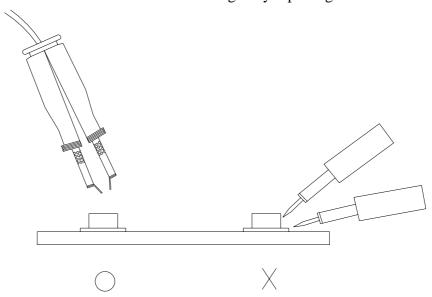
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4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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